

10/20/2010

Docket No.: STL 3394.00

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

<i>In re</i> Application of:	Rajiv Yadav Ranjan	:	Confirmation No.:	2760
Serial No.:	10/776,203	:	Art Unit:	1795
Filed:	2/12/2004	:	Examiner:	Rodney Glenn McDonald
For:	METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS			

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUPPLEMENTAL AMENDMENT ACCOMPANYING ISSUE FEE PAYMENT

Sir:

In response to the Notice of Allowance mailed July 8, 2010 for the above captioned patent application, Applicants respectfully request entry of the following amendments.